

IN THE CLAIMS:

Please amend claim 20. The pending claims are as follows:

20. (Currently Amended) A method of manufacturing a radiation imaging apparatus comprising:

    a plurality of imaging elements comprising each a plurality of pixels and an external terminal,

    wherein a lead constituting the external terminal ~~is extend~~ extends to the side opposite to a light receiving surface ~~each~~ of the imaging element through a space between [[the]] adjacent imaging elements;

    comprising the following steps [[of;]] of:

        forming [[the]] a first planarization layer which covers said external terminal, on the light receiving surface ~~and covering~~;

        forming [[the]] a second ~~planarization~~ planarization layer on said first planarization layer; and

        forming a substrate on which a scintillator is formed on said second planarization layer via [[a]] an adhesive layer.